

N and P Channel Enhancement Mode Power MOSFET

Description

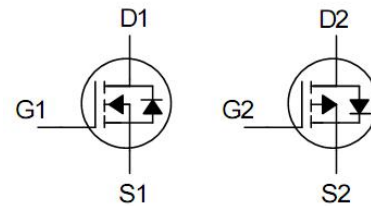
The PE8322CG uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.

General Features

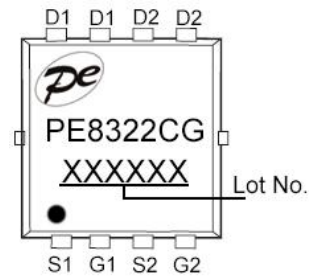
- **N-Channel**
 - $V_{DS} = 30V, I_D = 22A$
 - $R_{DS(ON)} < 14m\Omega @ V_{GS}=10V$
 - $R_{DS(ON)} < 20m\Omega @ V_{GS}=4.5V$
- **P-Channel**
 - $V_{DS} = -30V, I_D = -20A$
 - $R_{DS(ON)} < 30m\Omega @ V_{GS}=-10V$
 - $R_{DS(ON)} < 46m\Omega @ V_{GS}=-4.5V$
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

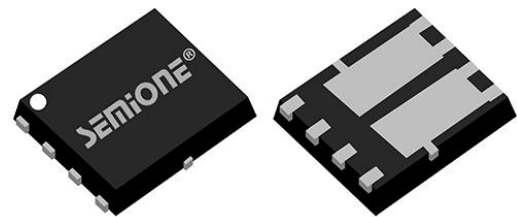
- DC motor
- PWM applications



Schematic diagram



Marking and pin assignment



DFN5x6-8L

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

| Parameter | Symbol | N-Channel | P-Channel | Unit |
|--|----------------|------------|-----------|------------|
| Drain-Source Voltage | V_{DS} | 30 | -30 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | ± 20 | V |
| Drain Current-Continuous ($T_C=25^\circ C$) | I_D | 22 | -20 | A |
| Pulsed Drain Current (Note 1) | I_{DM} | 66 | -60 | A |
| Maximum Power Dissipation ($T_C=25^\circ C$) | P_D | 20 | 20 | W |
| Avalanche Current | I_{AS} | 27 | -25 | A |
| Avalanche Energy (L=0.1mH) | E_{AS} | 36 | 31 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | | $^\circ C$ |

Thermal Characteristic

| | | | |
|---|-----------------|-----|--------------|
| Thermal Resistance, Junction-to-Case (Note 2) | $R_{\theta JC}$ | 6.2 | $^\circ C/W$ |
|---|-----------------|-----|--------------|

N-Channel Electrical Characteristics (TC=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|---|-----|------|-----------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 30 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=30V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1.0 | 1.6 | 2.2 | V |
| Drain-Source On-State Resistance | $R_{DS(on)}$ | $V_{GS}=10V, I_D=8A$ | - | 12.5 | 14 | m Ω |
| | | $V_{GS}=4.5V, I_D=6A$ | - | 17.5 | 20 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=10V, I_D=8A$ | 10 | - | - | S |
| Dynamic Characteristics (Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=15V, V_{GS}=0V,$ $F=1.0MHz$ | - | 1140 | - | pF |
| Output Capacitance | C_{oss} | | - | 120 | - | pF |
| Reverse Transfer Capacitance (Note 4) | C_{rss} | | - | 110 | - | pF |
| Switching Characteristics | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=15V, I_D=2A, R_L=1\Omega,$ $V_{GS}=10V, R_G=3\Omega$ | - | 4.2 | - | nS |
| Turn-on Rise Time | t_r | | - | 8.2 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 31 | - | nS |
| Turn-Off Fall Time | t_f | | - | 4 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=15V, I_D=8A, V_{GS}=10V$ | - | 9.5 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 4 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 3.5 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V_{SD} | $V_{GS}=0V, I_S=1A$ | - | - | 1.2 | V |
| Diode Forward Current (Note 2) | I_S | | - | - | 11 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.

Typical Electrical and Thermal Characteristics

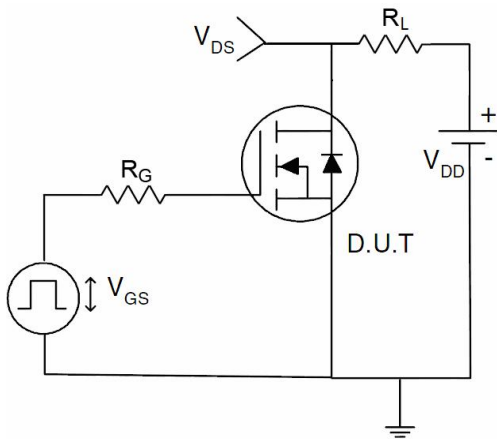


Figure 1 Switching Test Circuit

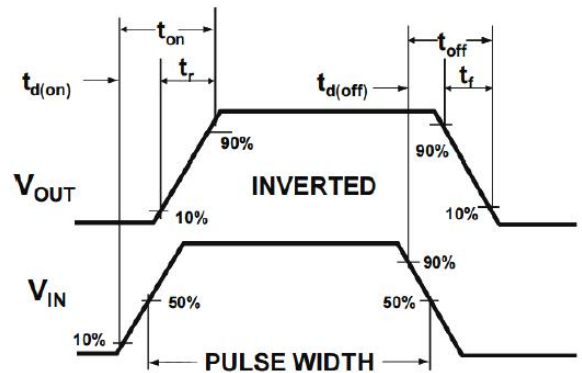
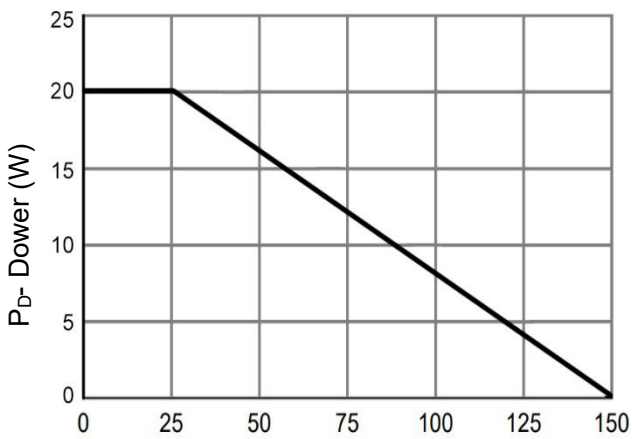
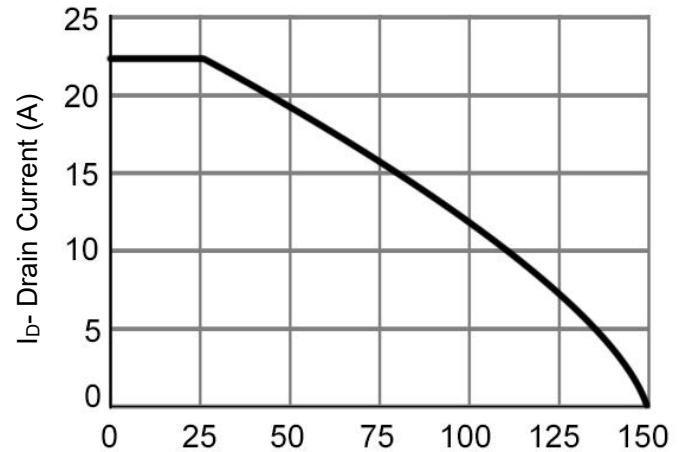


Figure 2 Switching Waveform



T_J-Junction Temperature (°C)

Figure 3 Power De-rating



T_J-Junction Temperature (°C)

Figure 4 Drain Current

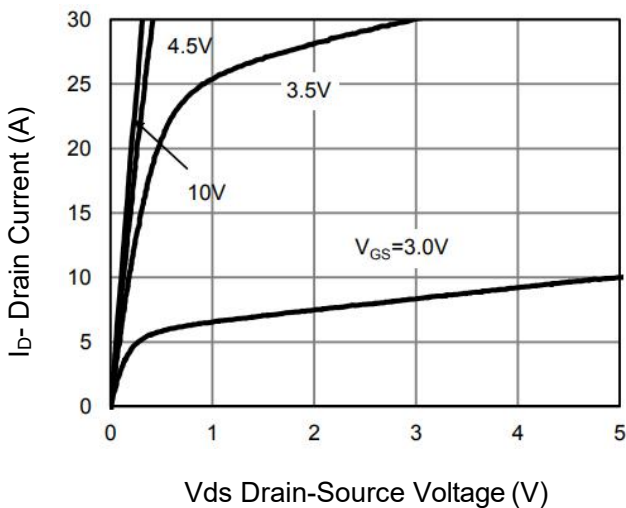


Figure 5 Output Characteristics

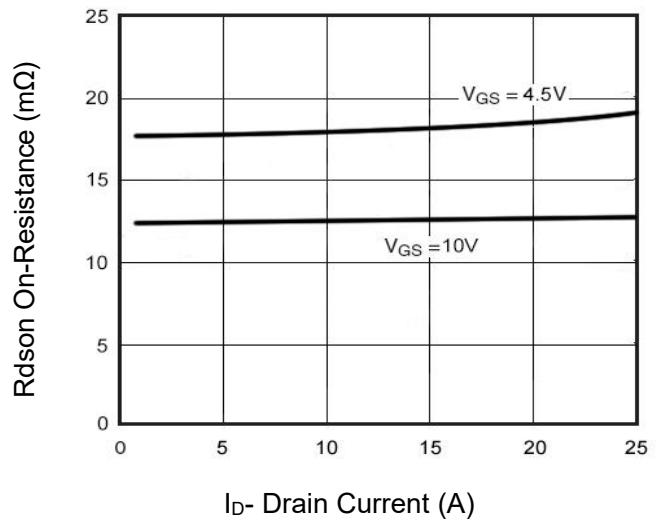


Figure 6 R_{dson} vs Drain Current

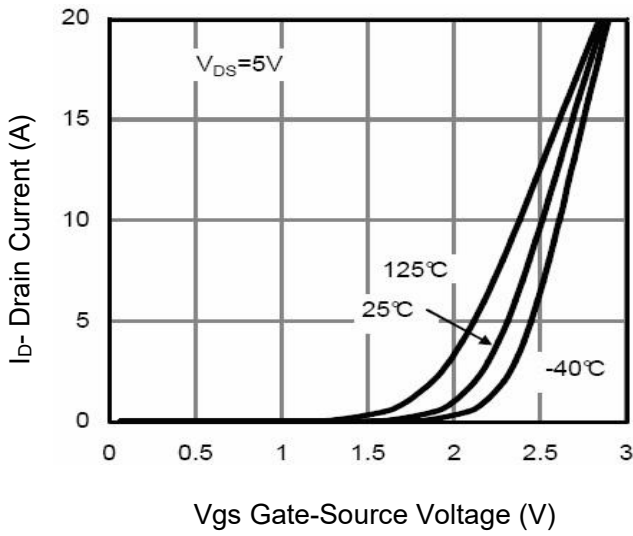


Figure 7 Transfer Characteristics

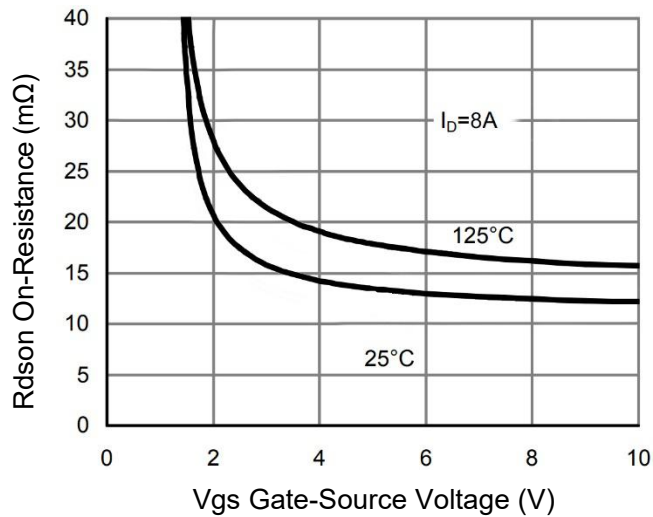


Figure 9 Rdson vs Vgs

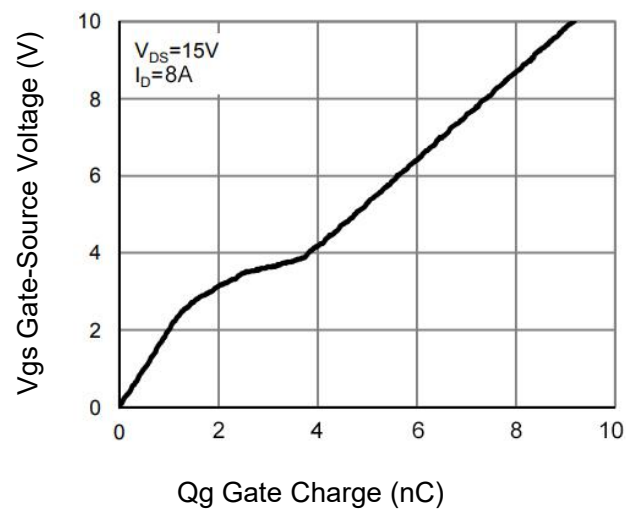


Figure 11 Gate Charge

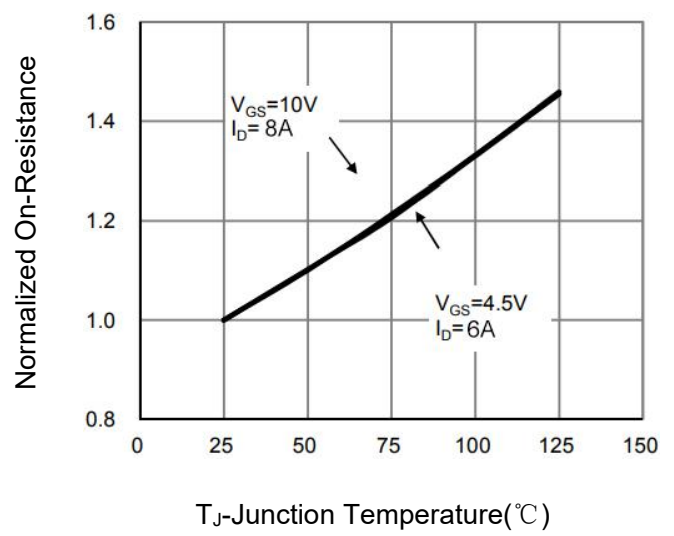


Figure 8 Rdson vs Junction Temperature

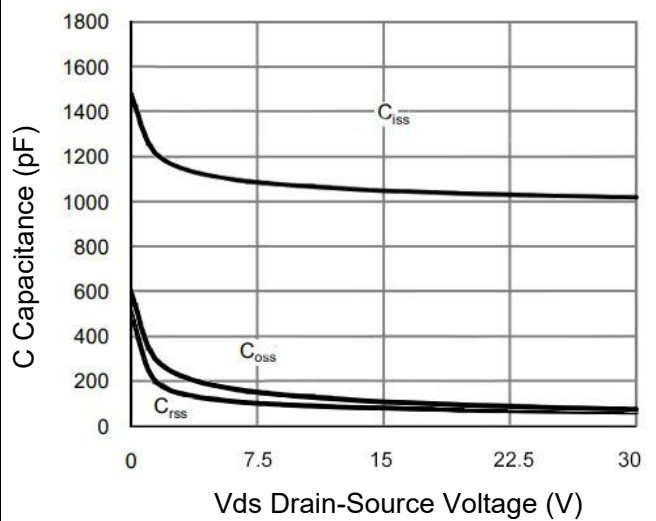


Figure 10 Capacitance vs Vds

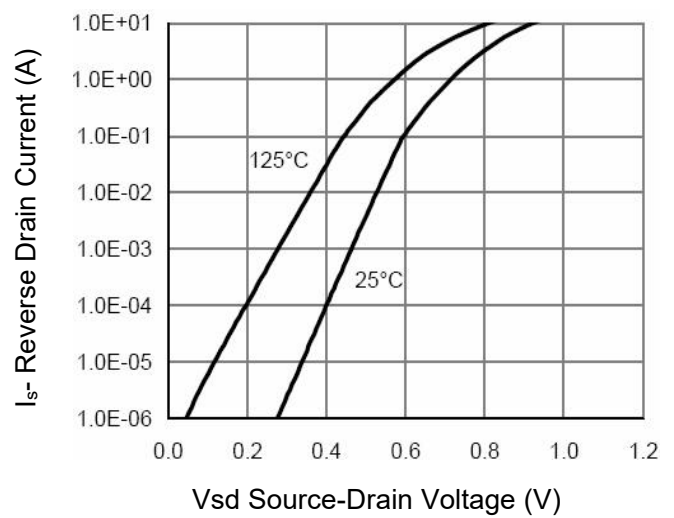


Figure 12 Source- Drain Diode Forward

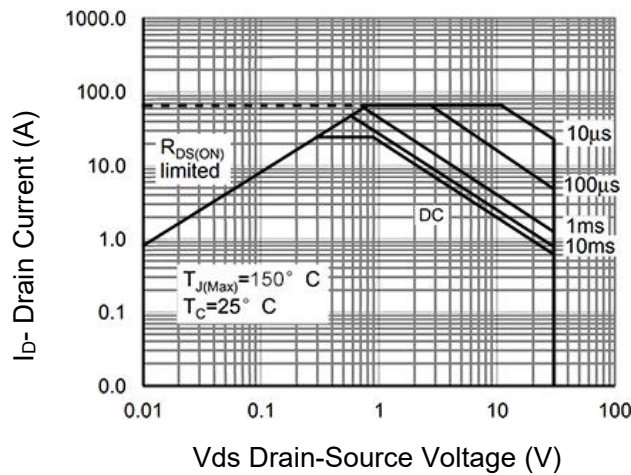


Figure 13 Safe Operation Area

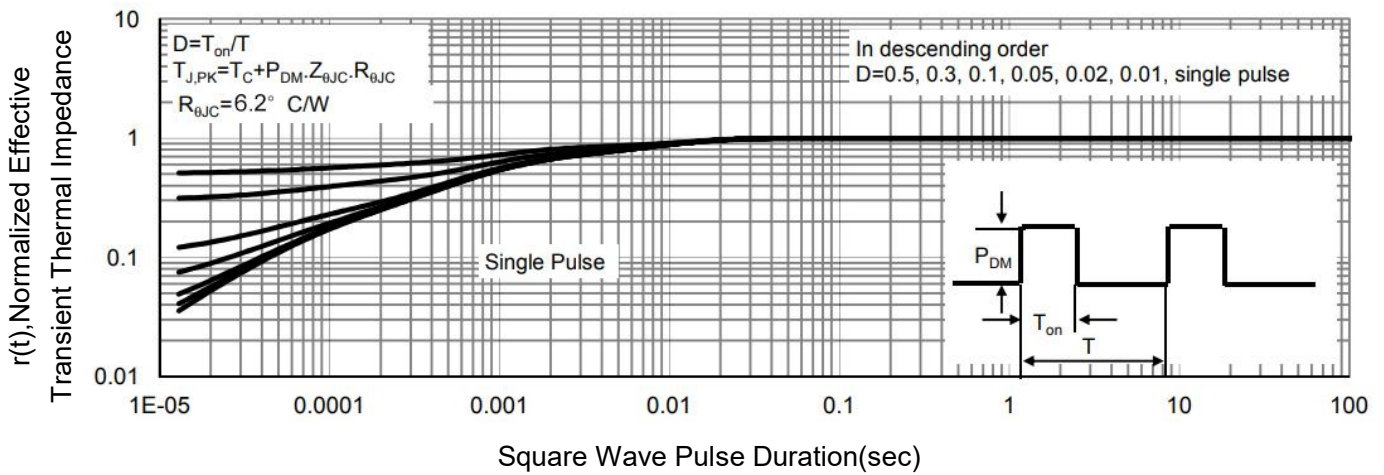


Figure 14 Normalized Maximum Transient Thermal Impedance

P-Channel Electrical Characteristics (TC=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|------|------|-----------|------------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=-250\mu A$ | -30 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-30V, V_{GS}=0V$ | - | - | -1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu A$ | -1.0 | -1.6 | -2.2 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=-10V, I_D=-7A$ | - | 25 | 30 | m Ω |
| | | $V_{GS}=-4.5V, I_D=-5A$ | - | 36 | 46 | m Ω |
| Forward Transconductance | g_{FS} | $V_{DS}=-10V, I_D=-7A$ | 12 | - | - | S |
| Dynamic Characteristics (Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=-15V, V_{GS}=0V,$ $F=1.0MHz$ | - | 480 | - | pF |
| Output Capacitance | C_{oss} | | - | 120 | - | pF |
| Reverse Transfer Capacitance (Note 4) | C_{rss} | | - | 54 | - | pF |
| Switching Characteristics | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=-15V, I_D=-2A, R_L=1\Omega,$ $V_{GS}=-10V, R_G=3\Omega$ | - | 8 | - | nS |
| Turn-on Rise Time | t_r | | - | 5 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 28 | - | nS |
| Turn-Off Fall Time | t_f | | - | 12 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=-15V, I_D=-8A,$ $V_{GS}=-10V$ | - | 14 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 3 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 2 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V_{SD} | $V_{GS}=0V, I_S=-1A$ | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | I_S | | - | - | -10 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.

Typical Electrical and Thermal Characteristics

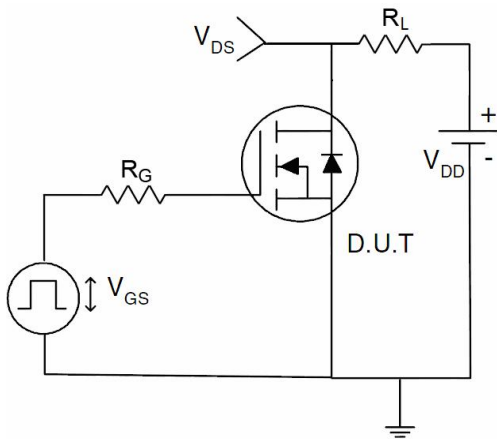


Figure 1 Switching Test Circuit

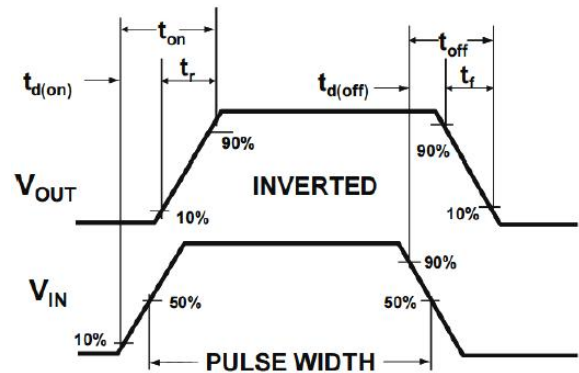


Figure 2 Switching Waveform

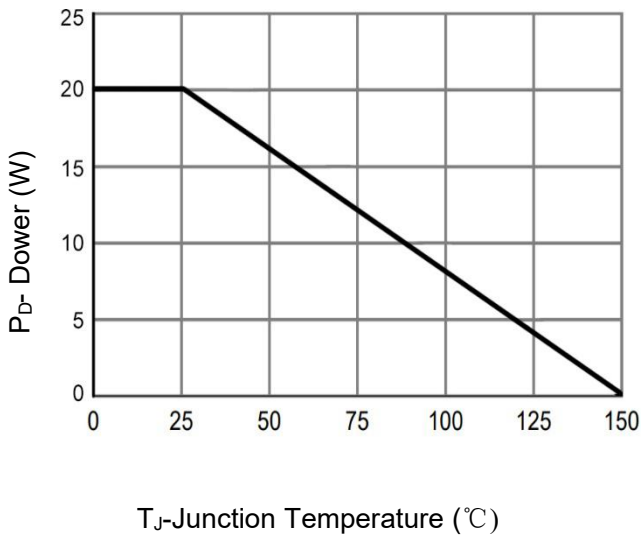


Figure 3 Power De-rating

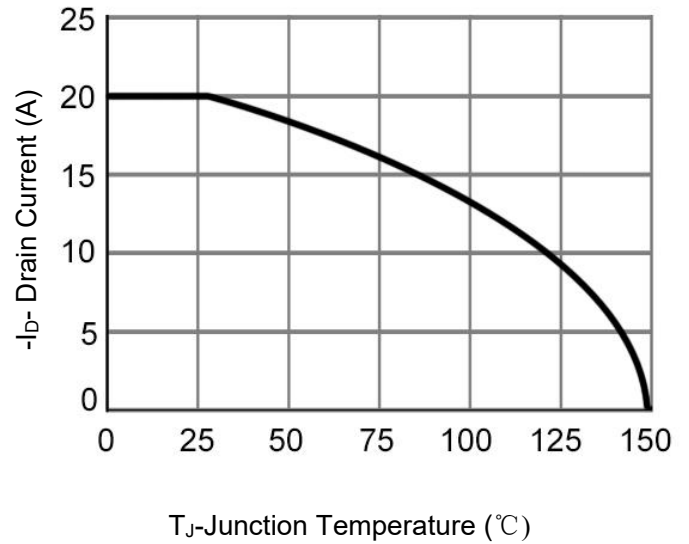


Figure 4 Drain Current

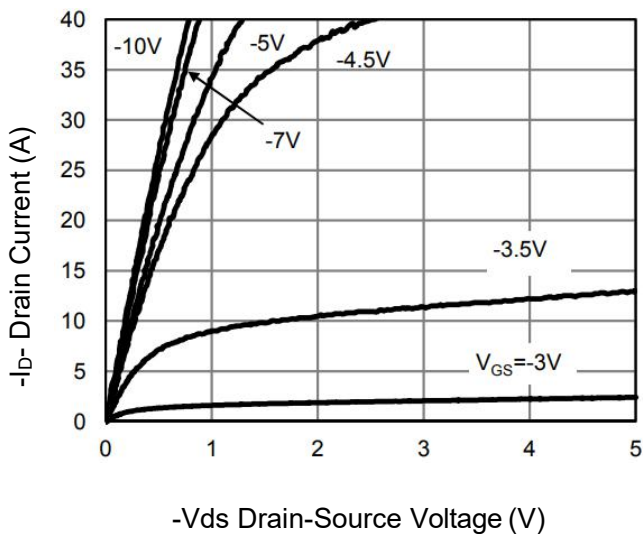


Figure 5 Output Characteristics

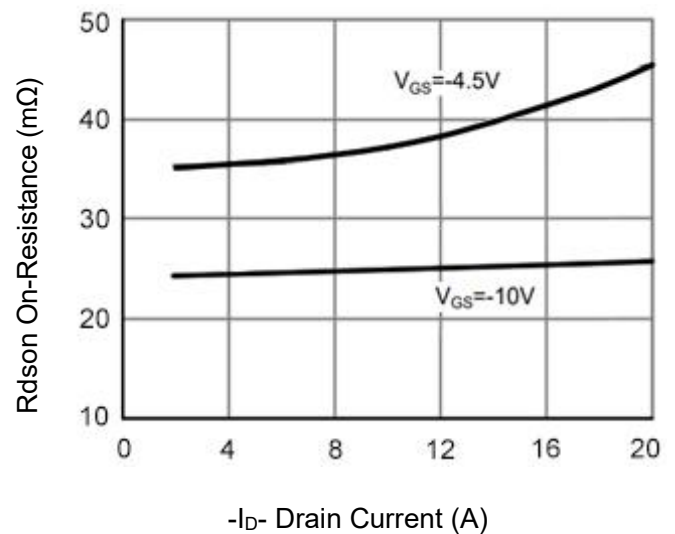


Figure 6 R_{dson} vs Drain Current

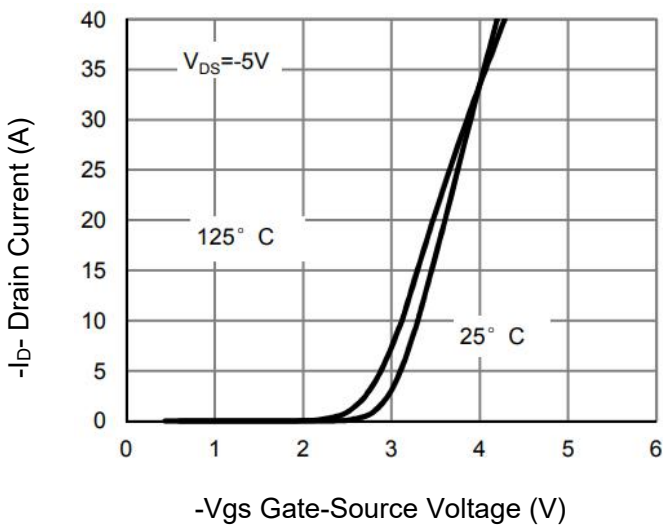


Figure 7 Transfer Characteristics

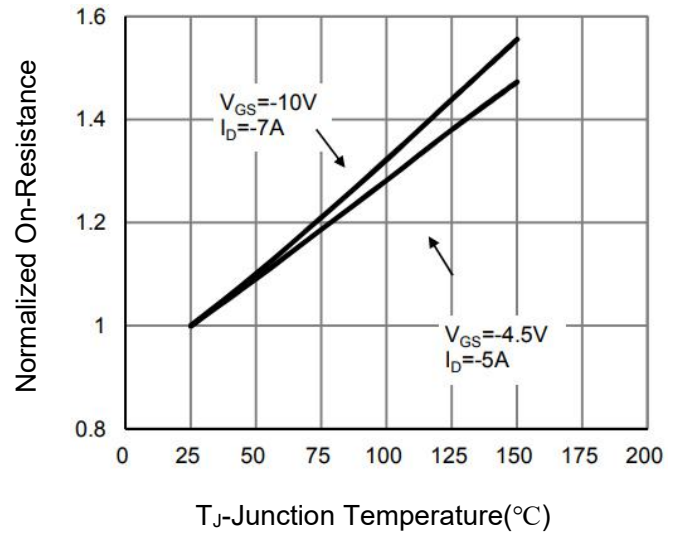


Figure 8 Rdson vs Junction Temperature

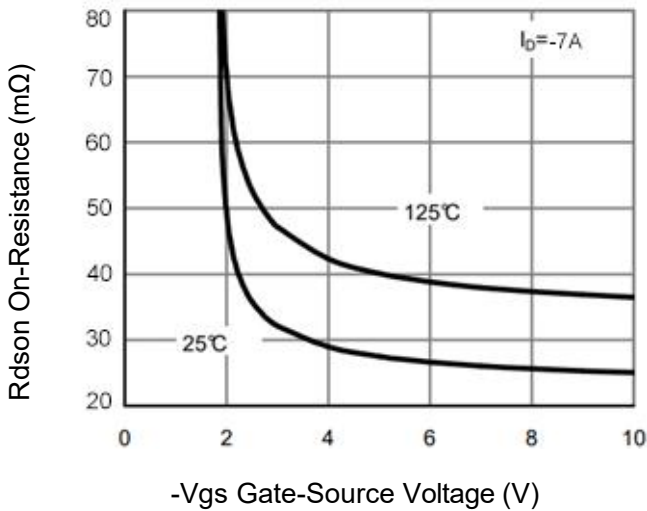


Figure 9 Rdson vs Vgs

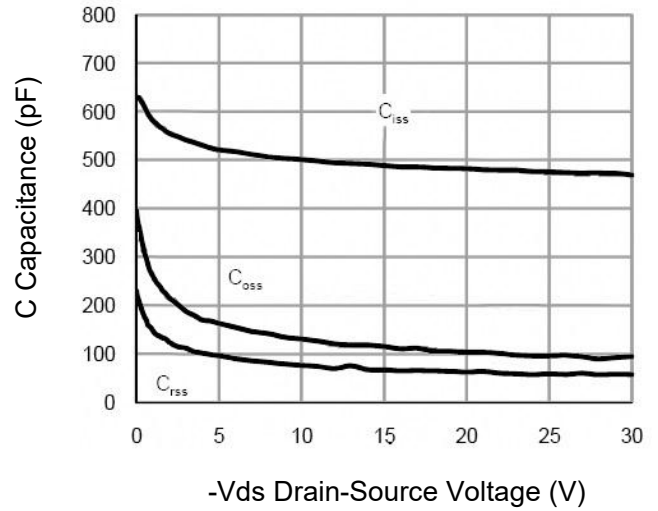


Figure 10 Capacitance vs Vds

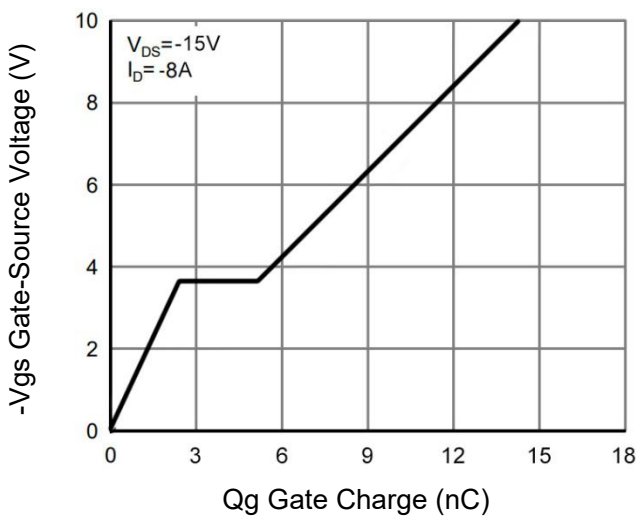


Figure 11 Gate Charge

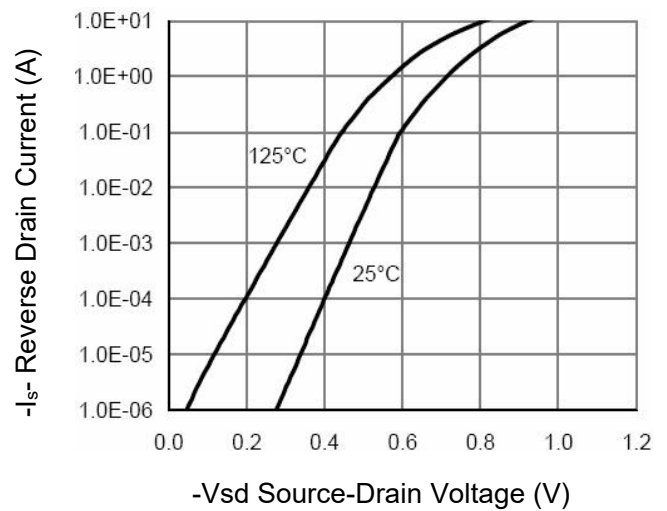


Figure 12 Source- Drain Diode Forward

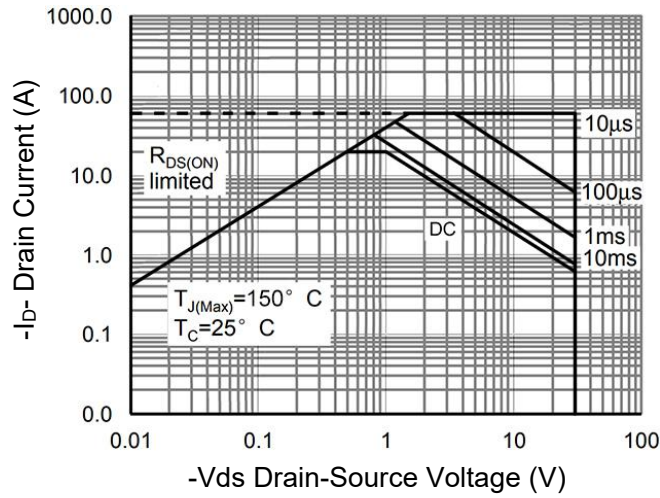


Figure 13 Safe Operation Area

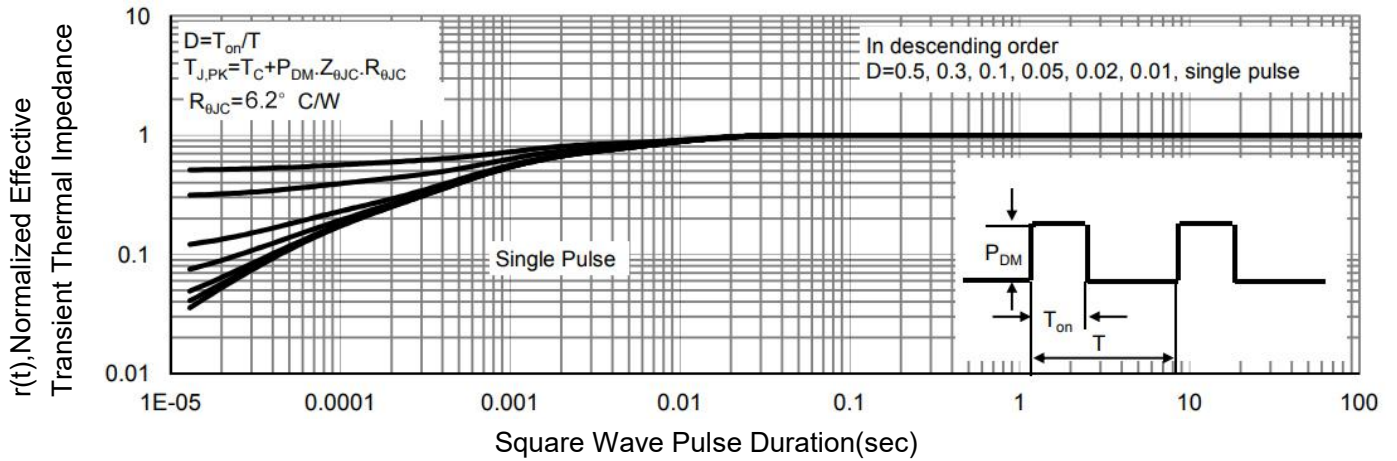
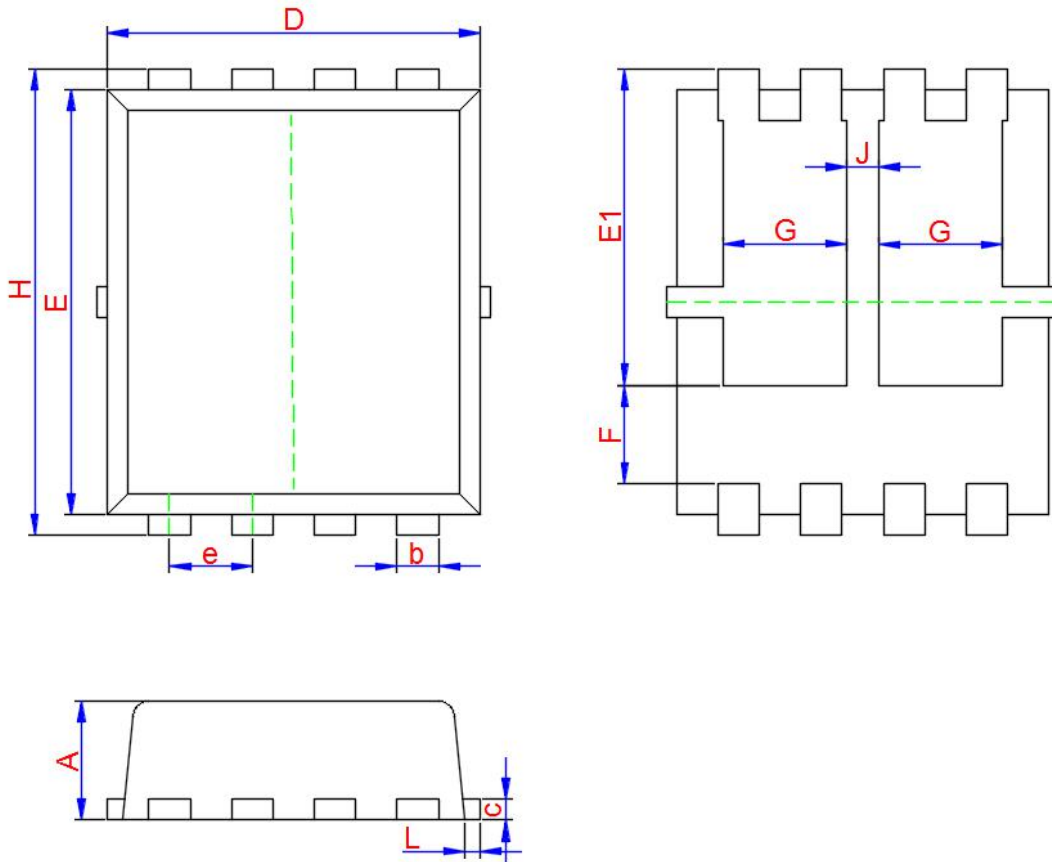


Figure 14 Normalized Maximum Transient Thermal Impedance

DFN5x6-8L Package Information



| Symbol | Dimensions In Millimeters | | |
|--------|---------------------------|-------|-------|
| | Min. | Typ. | Max. |
| A | 0.850 | 0.950 | 1.050 |
| b | 0.300 TYP. | | |
| c | 0.254 TYP. | | |
| D | 5.100 | 5.200 | 5.300 |
| e | 1.270 TYP. | | |
| E | 5.450 | 5.550 | 5.650 |
| E1 | 3.900 | 4.100 | 4.300 |
| F | 1.090 | 1.290 | 1.490 |
| G | 1.500 | 1.700 | 1.900 |
| H | 5.850 | 6.050 | 6.250 |
| J | 0.400 | 0.600 | 0.800 |
| L | 0.150 MAX. | | |